

Pb-free
HEAT



5352K Series

Single Color Rectangular Shape Type

Features

Package	1 × 5 Rectangular Shape type, MBG,MPG : Green Surface Diffused epoxy MPY,MAY : Yellow Surface Diffused epoxy MAA : Orange Surface Diffused epoxy MVR,BR,MPR : Red Surface Diffused epoxy
Product features	<ul style="list-style-type: none">• Outer Dimension 1 × 5 Rectangular shape type• Operation temperature range. Storage Temperature : -30°C~100°C Operating Temperature : -30°C~85°C• Lead-free soldering compatible• RoHS compliant
Dominant wavelength	Green : 558nm (MBG) 567nm (MPG) Yellow Green : 572nm (MPY) Yellow : 590nm (MAY) Orange : 606nm (MAA) Red : 624nm (MVR) 647nm (BR) 630nm (MPR)
Half Intensity Angle	134 deg.
Die materials	MBG, MPG, MPY, MPR : GaP MAY, MAA, MVR : GaAsP BR : GaAlAs
Rank grouping parameter	Sorted by luminous intensity per rank taping
Soldering methods	TTW (Through The Wave) soldering and manual soldering
ESD	More than 2kV(HBM)
Packing	Bulk : 200pcs(MIN.)

Recommended Applications

Amusement Equipment, Electric Household Appliances, OA/FA, Other General Applications

Color and Luminous Intensity

(Ta=25°C)

Part No.	Material	Emitted Color	Lens Color		Dominant Wavelength λ_d (nm)		Luminous Intensity I_v (mcd)		
					TYP.	I_f	MIN.	TYP.	I_f
					MBG5352K	GaP	Green	Green	Surface Diffused
MPG5352K	GaP	Green	567	20	1.5	3.0	20		
MPY5352K	GaP	Yellow Green	Yellow	572	20	2.0	4.0	20	
MAY5352K	GaAsP	Yellow		590	20	1.2	2.4	20	
MAA5352K	GaAsP	Orange	Orange	606	20	1.2	2.4	20	
MVR5352K	GaAsP	Red	Red	624	20	1.2	2.4	20	
BR5352K	GaAlAs	Red		647	20	1.5	3.0	20	
MPR5352K	GaP	Red		630	10	0.3	0.5	10	

Absolute Maximum Ratings

(Ta=25°C)

Item	Symbol	Absolute Maximum Ratings								Unit
		MBG	MPG	MPY	MAY	MAA	MVR	BR	MPR	
Power Dissipation	P_d	70	70	85	85	70	75	100	75	mW
Forward Current	I_F	25	25	30	30	25	30	50	30	mA
Pulse Forward Current ※1	I_{FRM}	60	60	75	75	60	75	300	75	mA
Derating (Ta=25°C or higher)	ΔI_F	0.33	0.33	0.40	0.40	0.33	0.40	0.67	0.40	mA/°C
Reverse Voltage	V_R	4	4	4	4	4	4	4	4	V
Operating Temperature	T_{opr}	-30~+85								°C
Storage Temperature	T_{stg}	-30~+100								°C

 ※1 I_{FRM} Measurement condition : Pulse Width ≤ 1 ms., Duty $\leq 1/20$.

Electro-Optical Characteristics(MBG,MPG,MPY,MAY,MAA,MVR,BR) (Ta=25°C)

Item	Conditions	Symbol	Characteristics								Unit
			MBG	MPG	MPY	MAY	MAA	MVR	BR		
Forward Voltage	I _F =20mA	V _F	TYP.	2.1	2.1	2.1	2.2	2.2	2.0	1.7	V
			MAX.	2.8	2.8	2.8	2.8	2.8	2.8	2.0	
Reverse Current	V _R =4V	I _R	MAX.	20	20	20	20	20	20	100	μ A
Peak Wavelength	I _F =20mA	λ _p	TYP.	555	560	570	580	605	630	660	nm
Dominant Wavelength	I _F =20mA	λ _d	TYP.	558	567	572	590	606	624	647	nm
Spectral Line Half Width	I _F =20mA	Δλ	TYP.	30	30	30	30	30	30	30	nm
Half Intensity Angle	I _F =20mA	2θ 1/2	TYP.	134	134	134	134	134	134	134	deg.

Electro-Optical Characteristics(MPR)

(Ta=25°C)

Item	Conditions	Symbol	Characteristics		Unit
				MPR	
Forward Voltage	I _F =10mA	V _F	TYP.	2.1	V
			MAX.	2.8	
Reverse Current	V _R =4V	I _R	MAX.	20	μ A
Peak Wavelength	I _F =10mA	λ _p	TYP.	700	nm
Dominant Wavelength	I _F =10mA	λ _d	TYP.	630	nm
Spectral Line Half Width	I _F =10mA	Δλ	TYP.	100	nm
Half Intensity Angle	I _F =10mA	2θ 1/2	TYP.	134	deg.

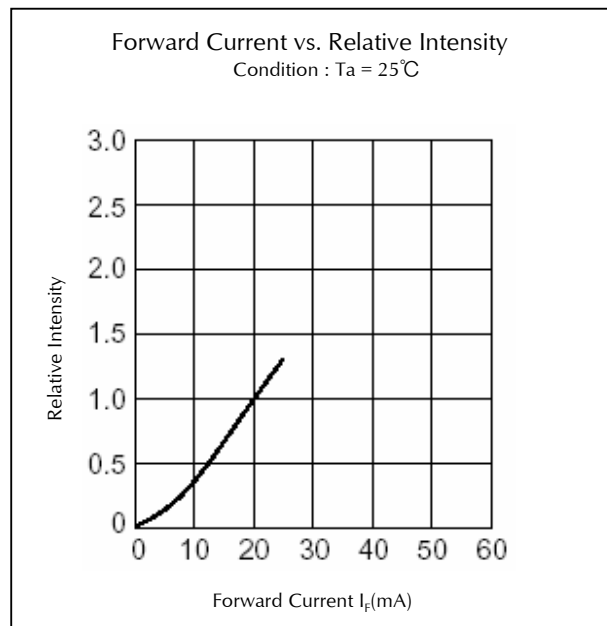
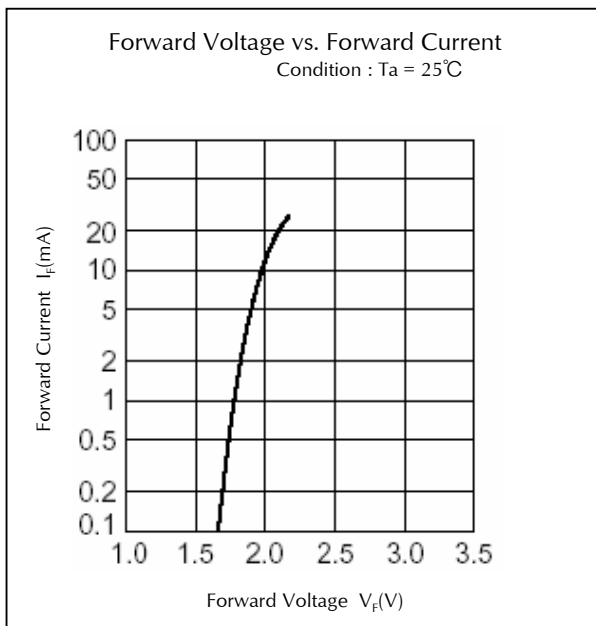
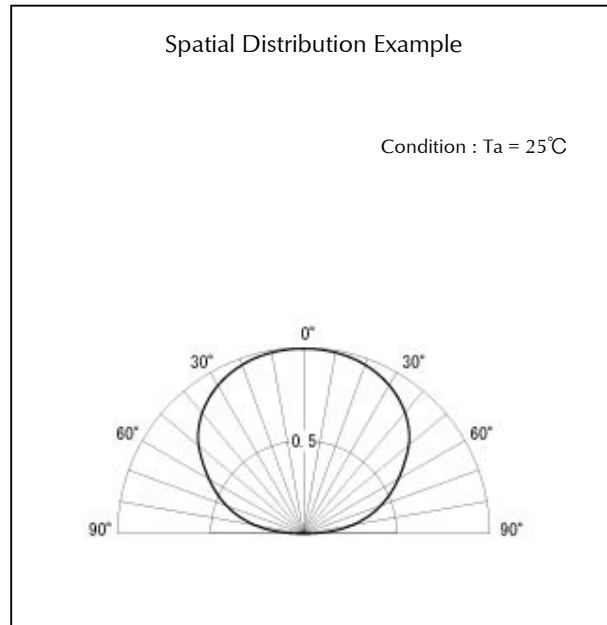
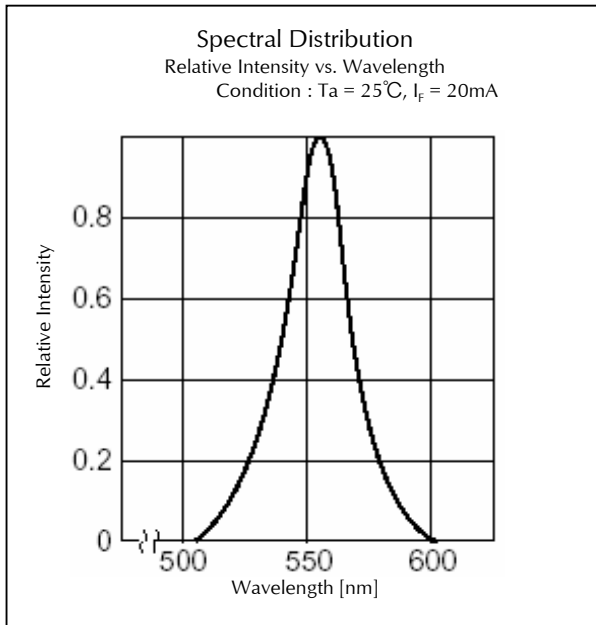
Luminous Intensity Rank

(Ta=25°C)

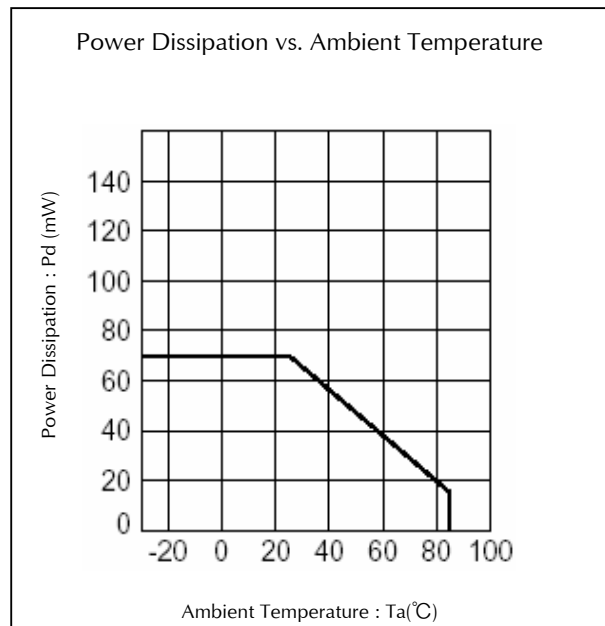
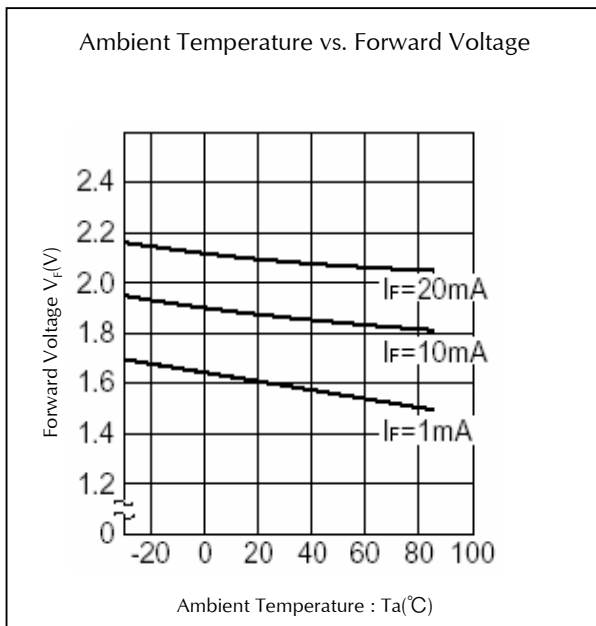
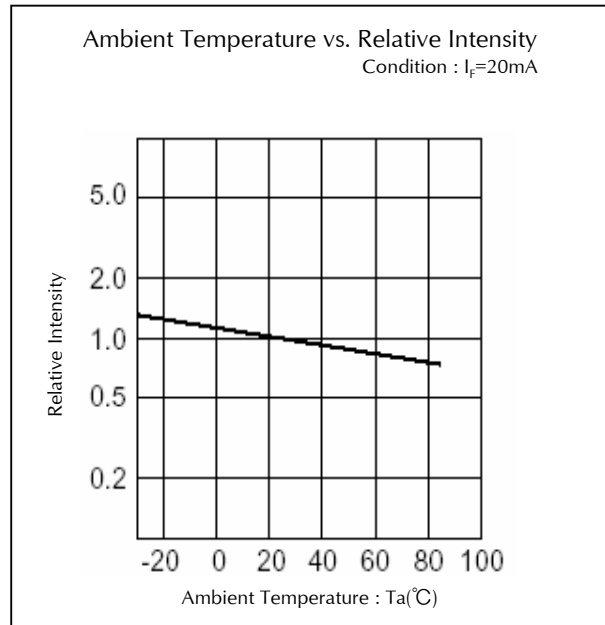
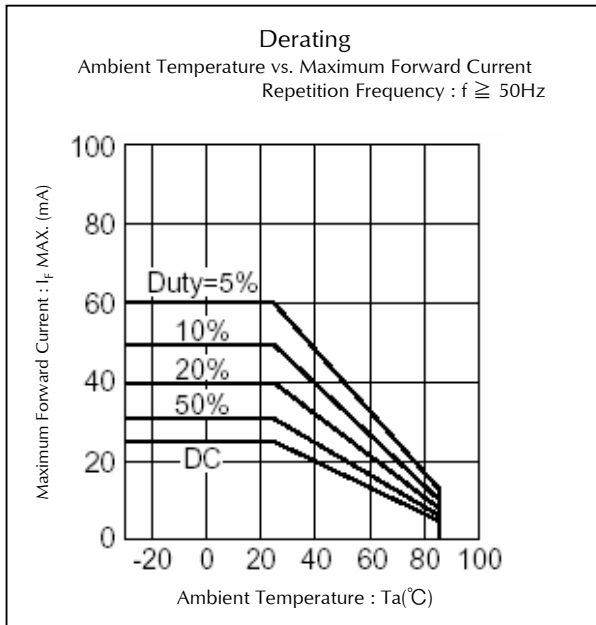
Rank	I _v (mcd)															
	MBG		MPG		MPY		MAY		MAA		MVR		BR		MPR	
	I _f =20mA		I _f =20mA		I _f =20mA		I _f =20mA		I _f =20mA		I _f =20mA		I _f =20mA		I _f =10mA	
	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.
A	0.5	1.0	1.5	3.0	2.0	4.0	1.2	2.4	1.2	2.4	1.2	2.4	1.5	3.0	0.30	0.60
B	0.7	1.4	2.1	4.2	2.8	5.6	1.6	3.2	1.6	3.2	1.6	3.2	2.1	4.2	0.42	0.84
C	1.0	2.0	3.0	6.0	4.0	8.0	2.4	4.8	2.4	4.8	2.4	4.8	3.0	6.0	0.60	1.20
D	1.4	2.8	4.2	8.4	5.6	11.2	3.2	6.4	3.2	6.4	3.2	6.4	4.2	8.4	0.84	1.68
E	2.0	-	6.0	-	8.0	-	4.8	-	4.8	-	4.8	-	6.0	-	1.20	-

Please contact our sales staff concerning rank designation.

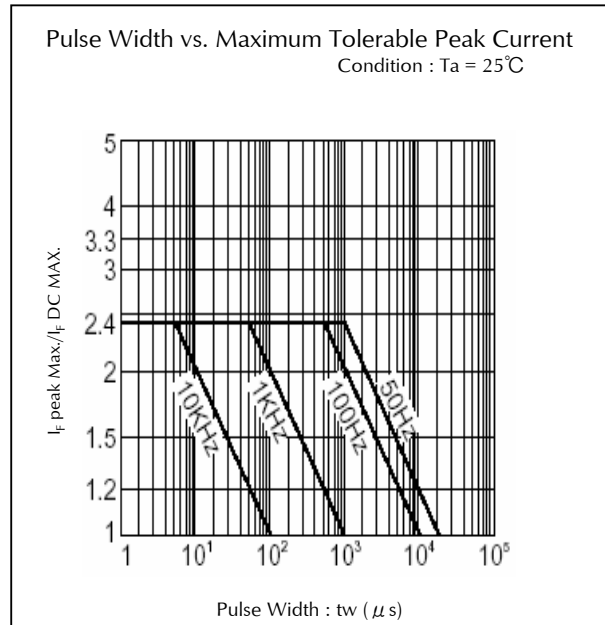
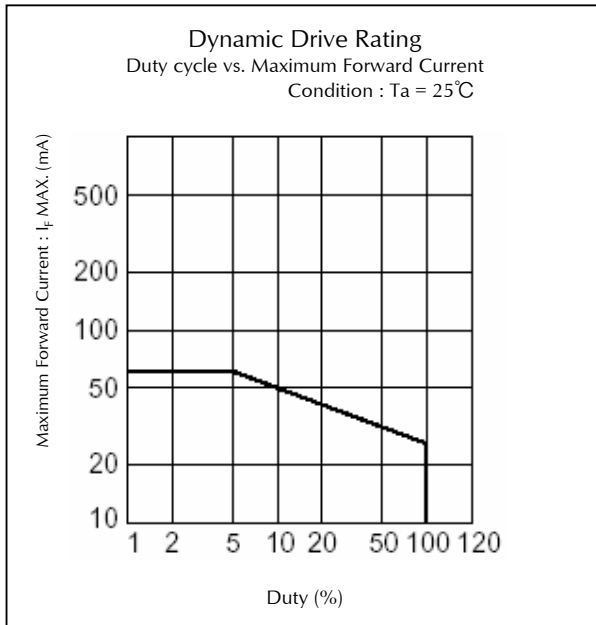
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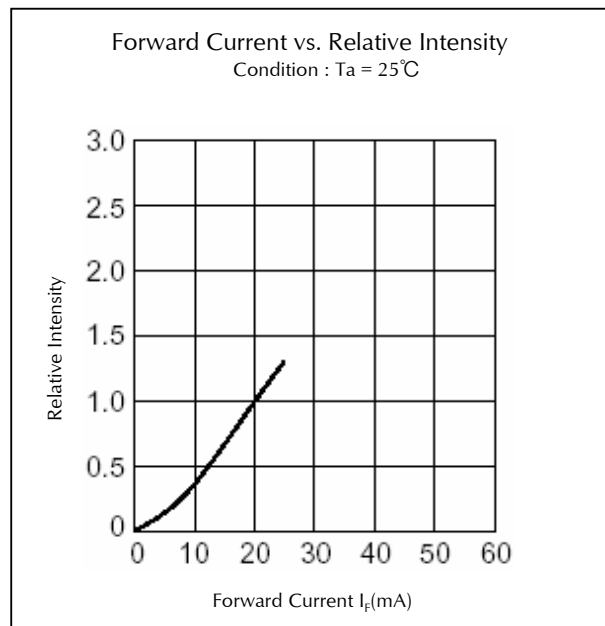
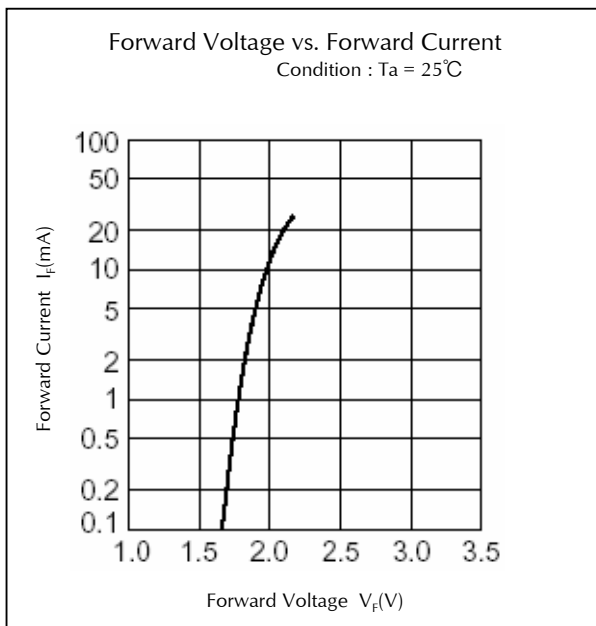
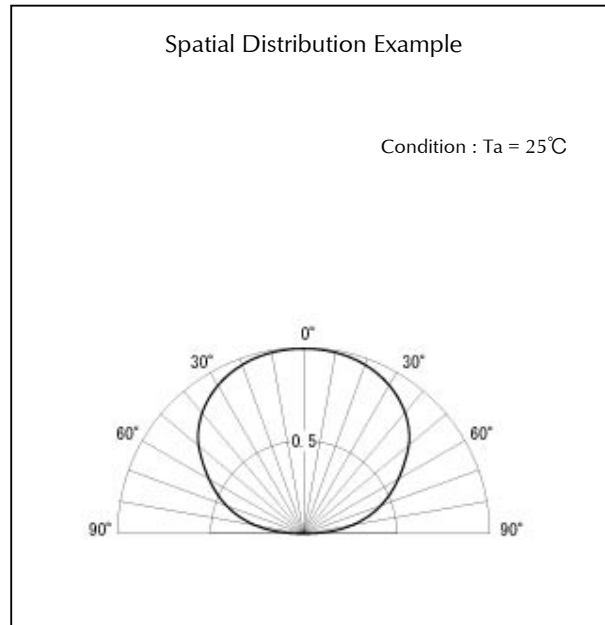
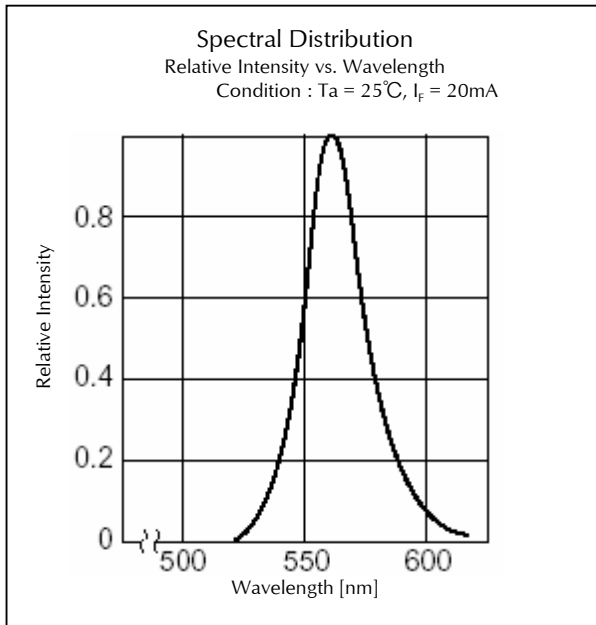
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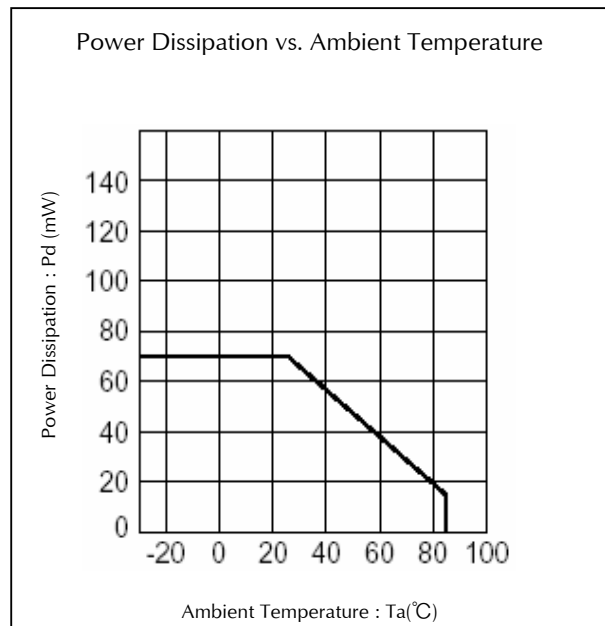
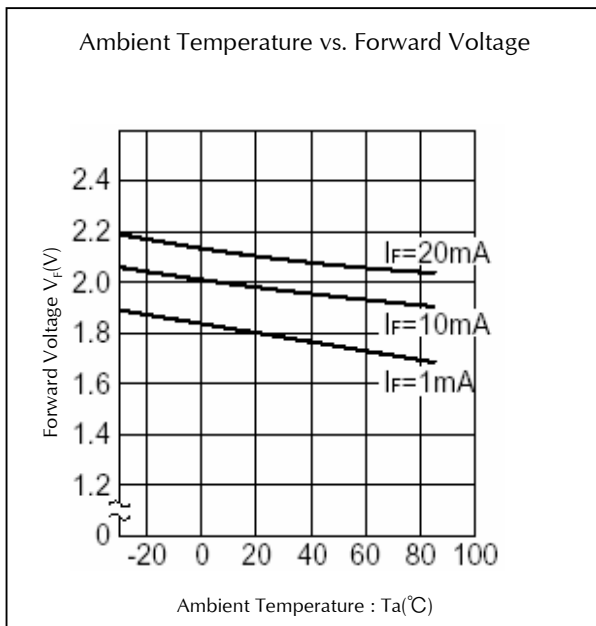
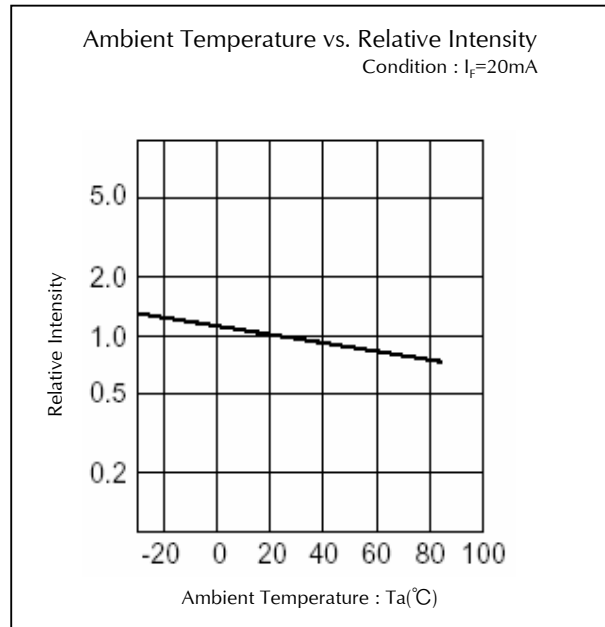
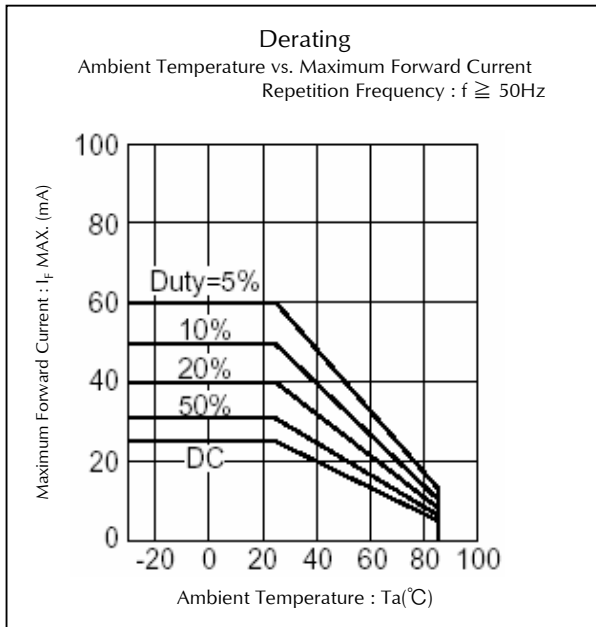
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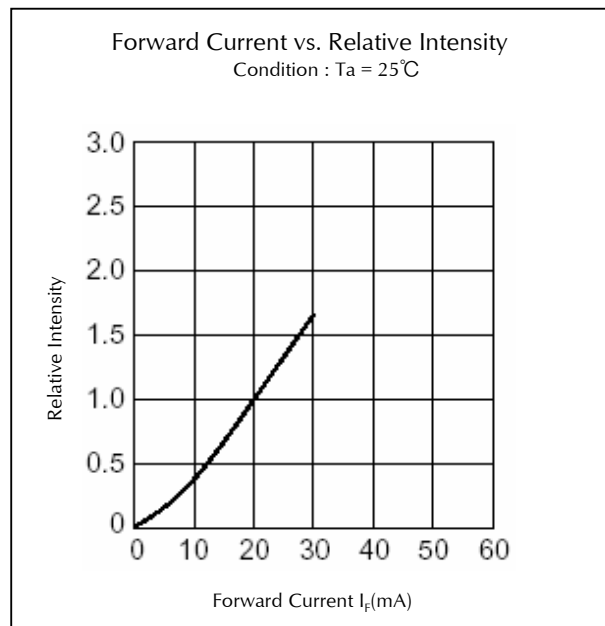
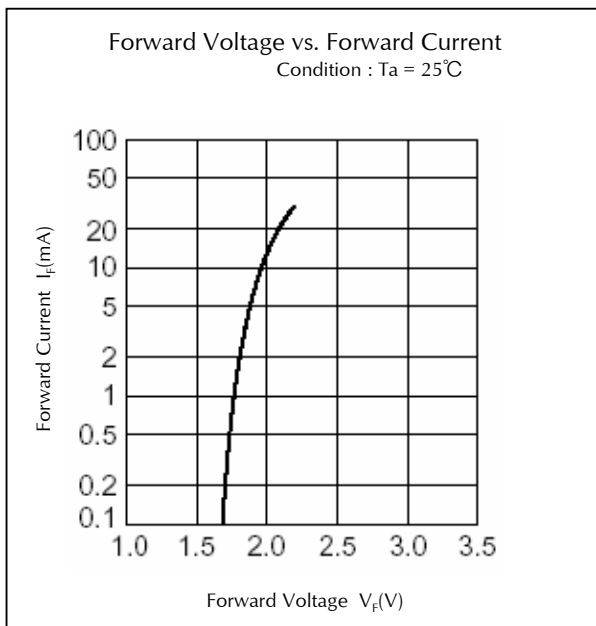
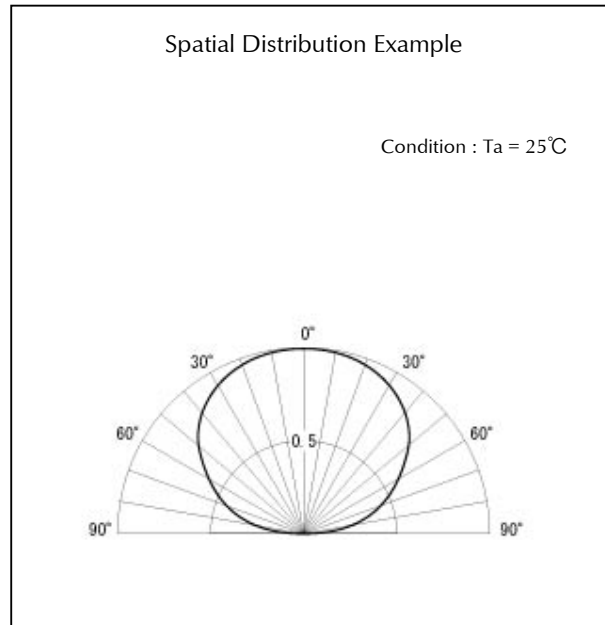
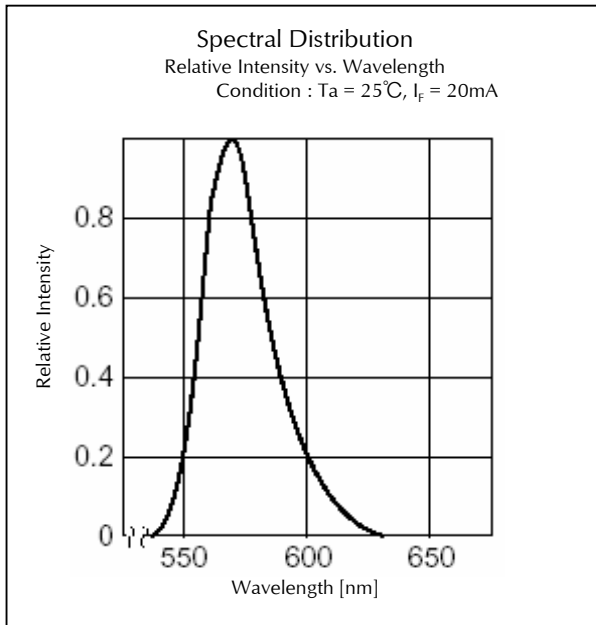
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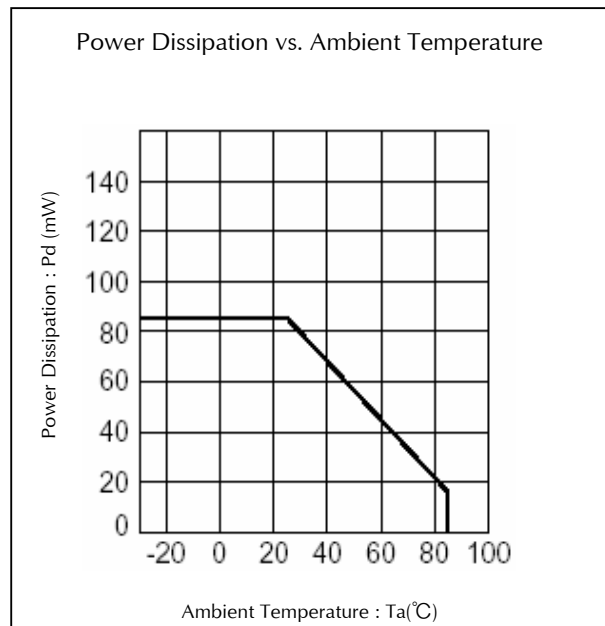
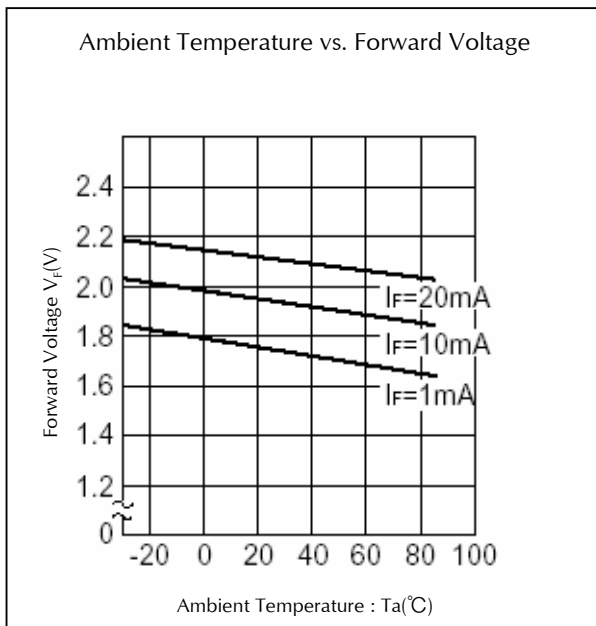
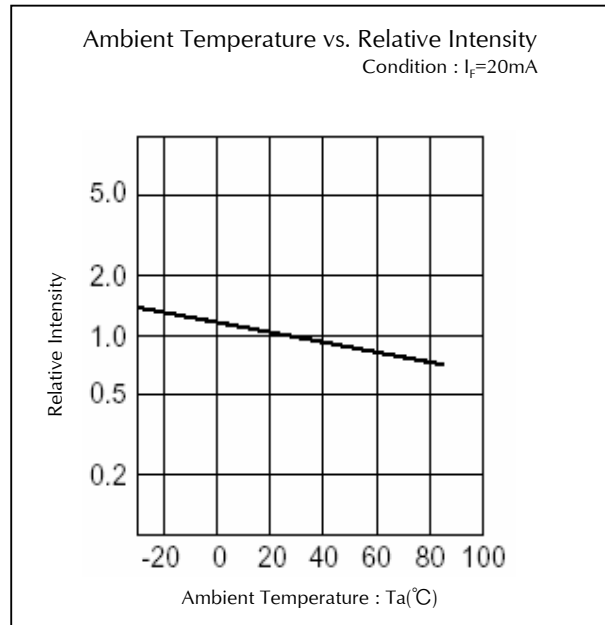
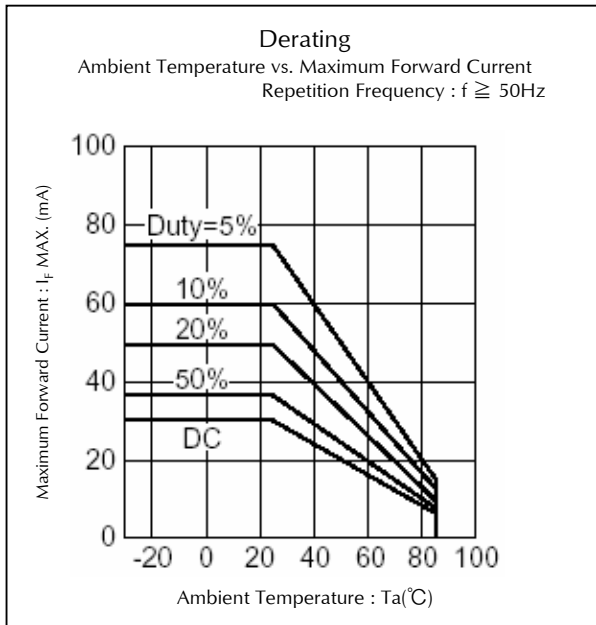
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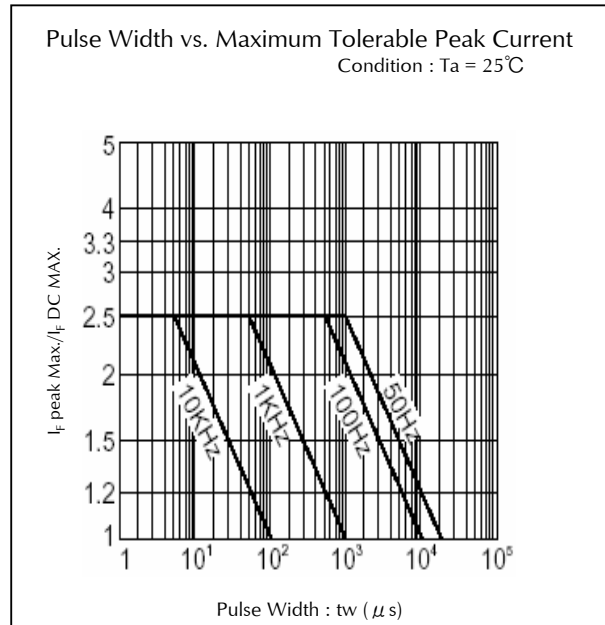
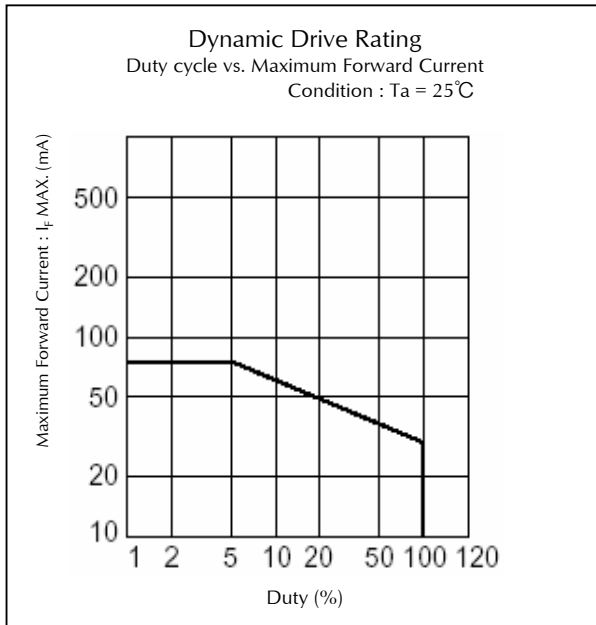
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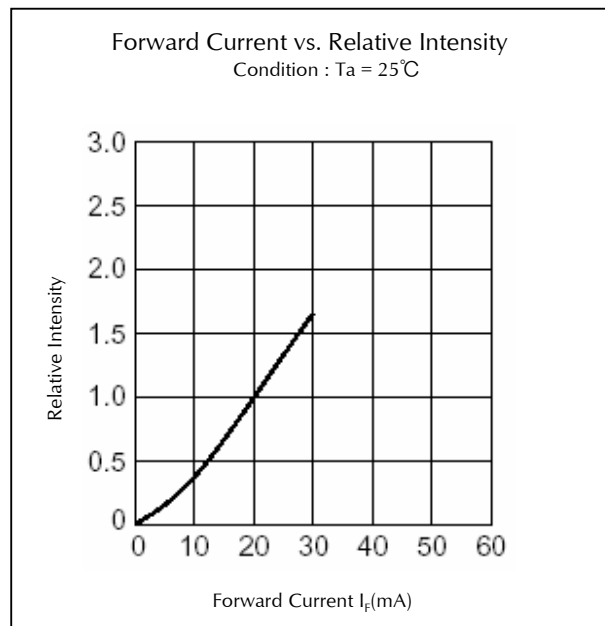
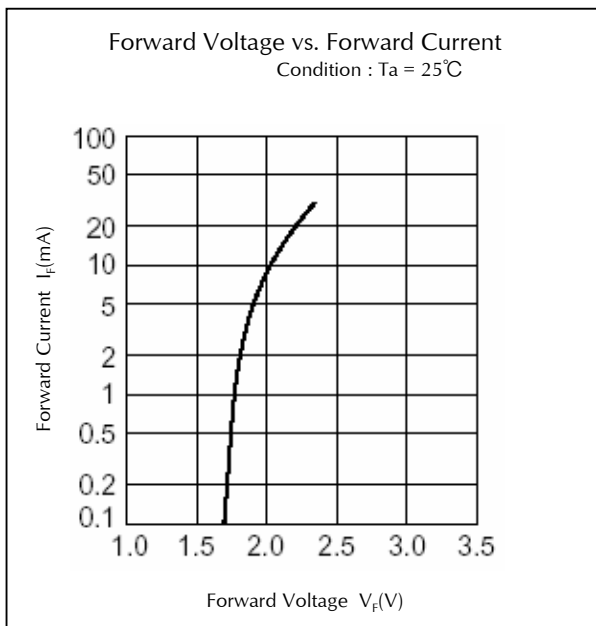
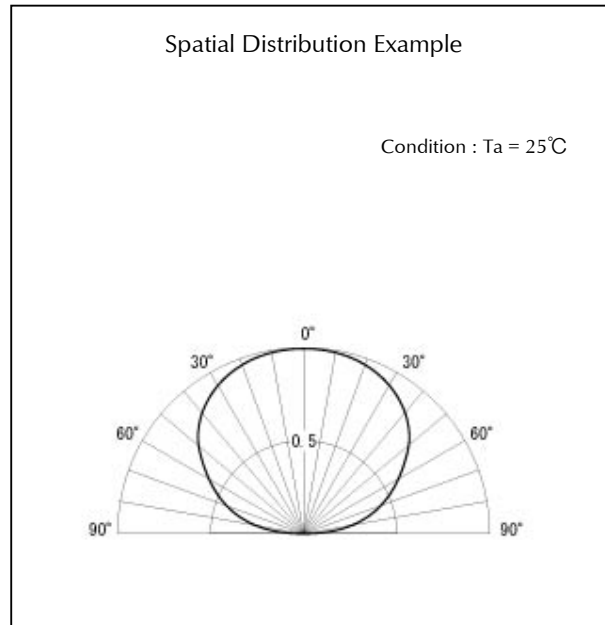
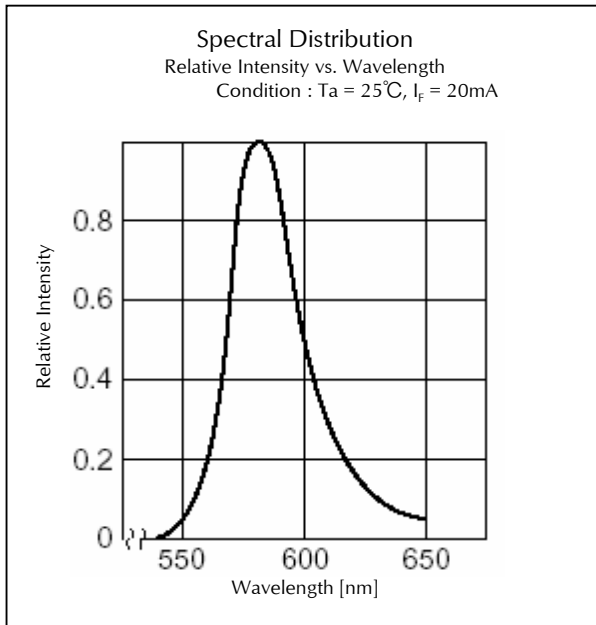
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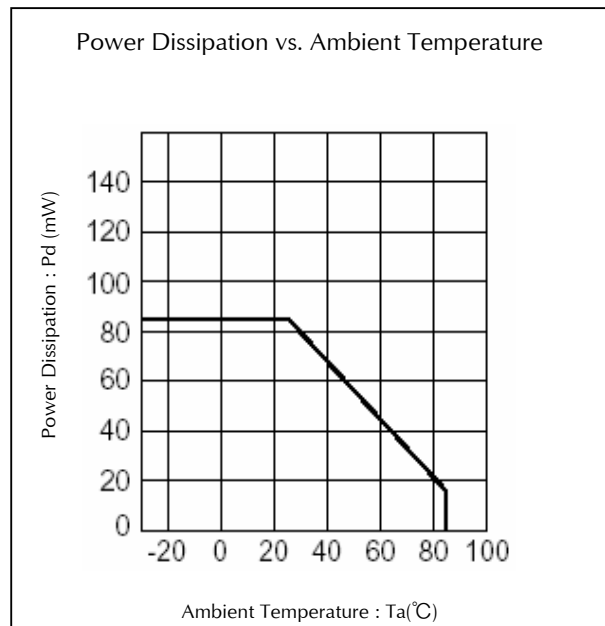
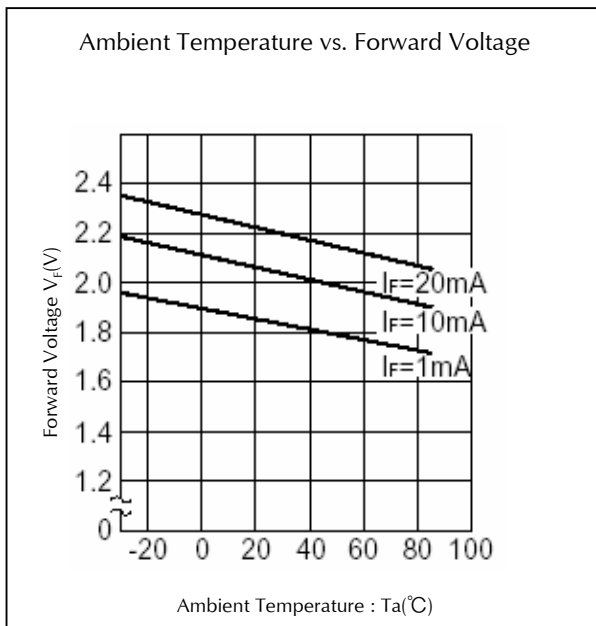
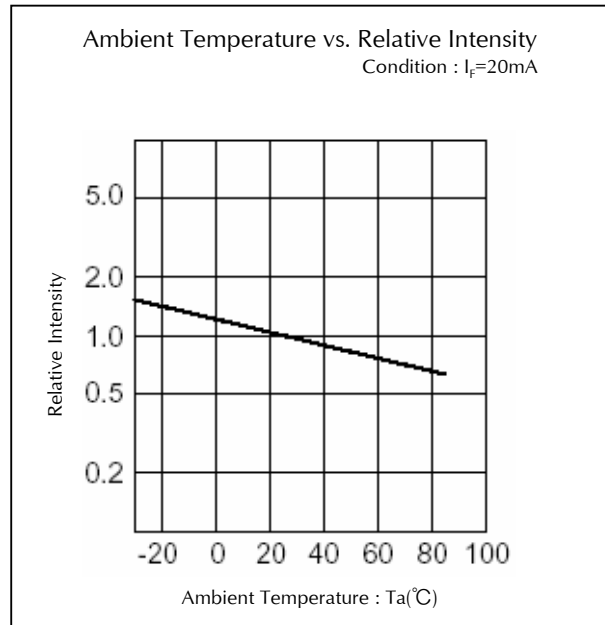
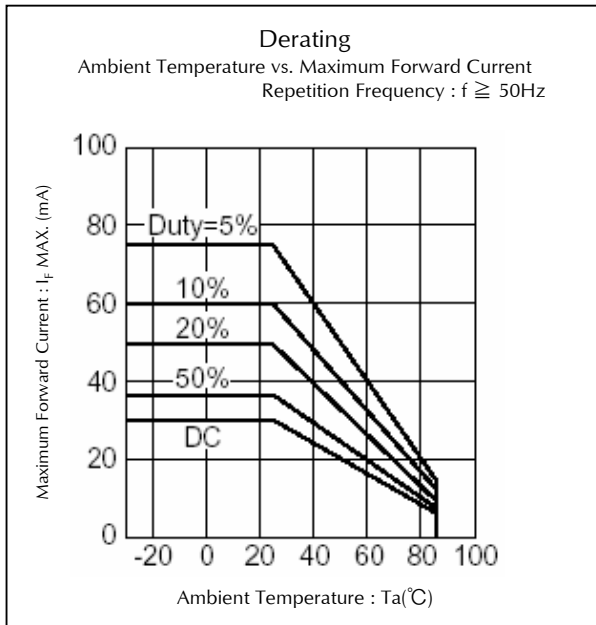
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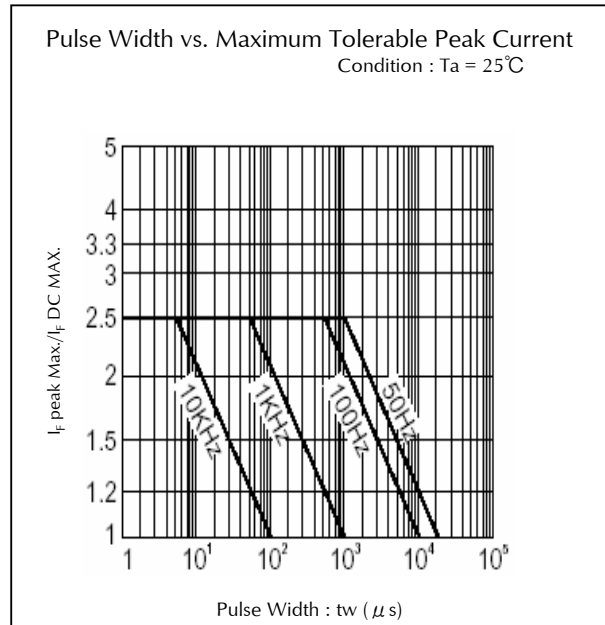
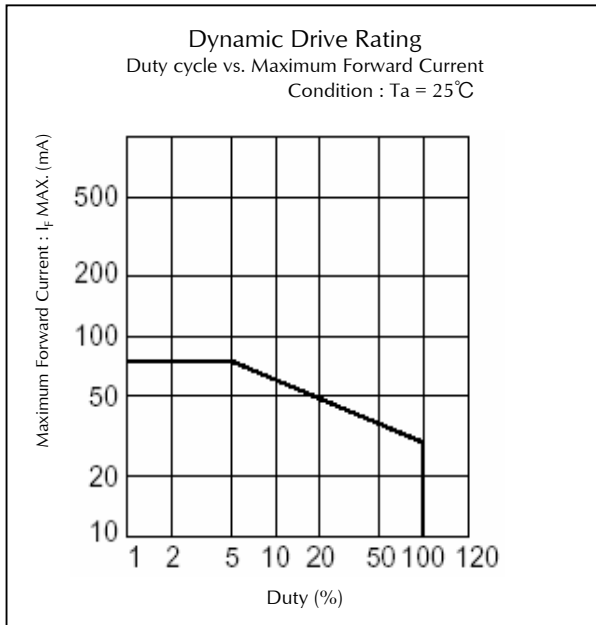
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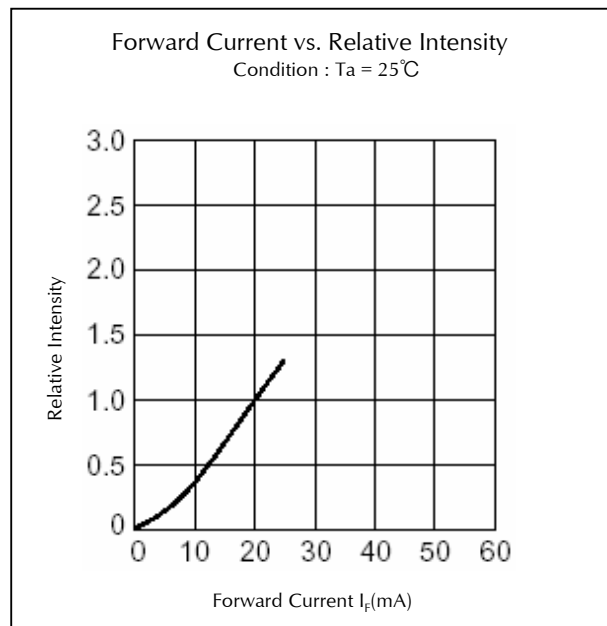
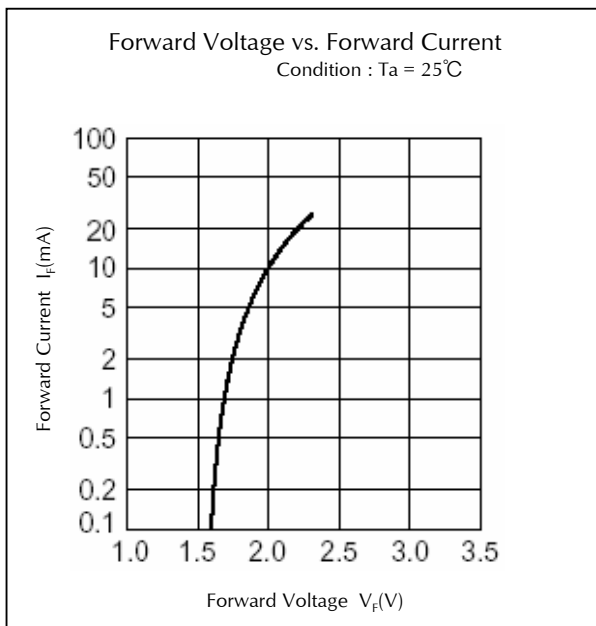
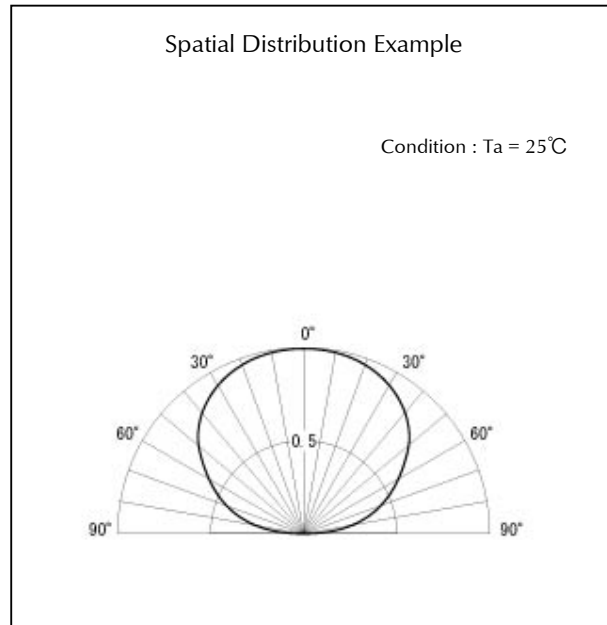
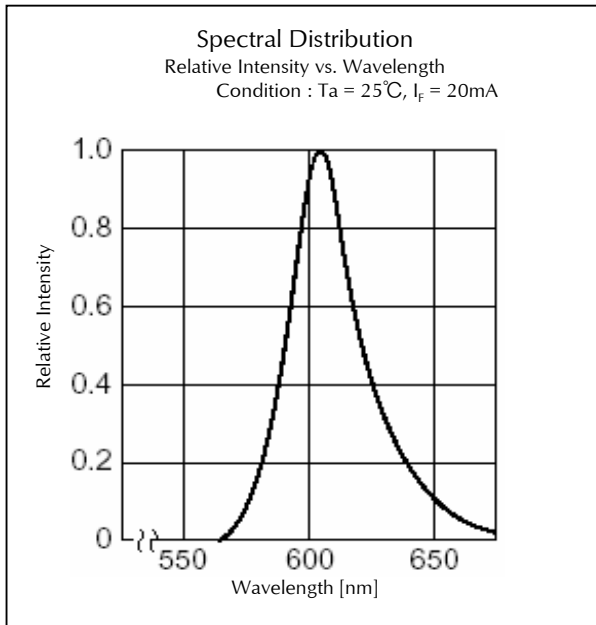
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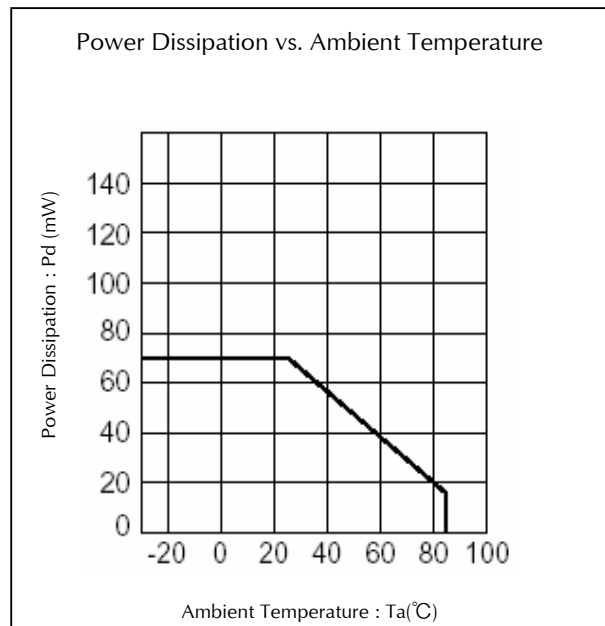
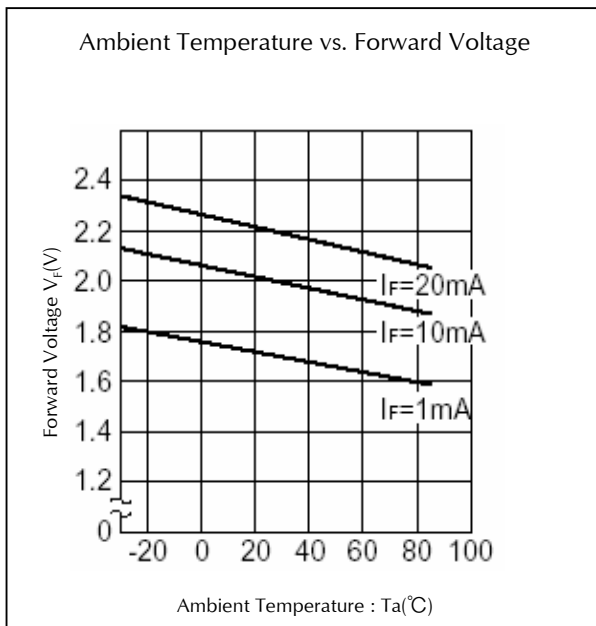
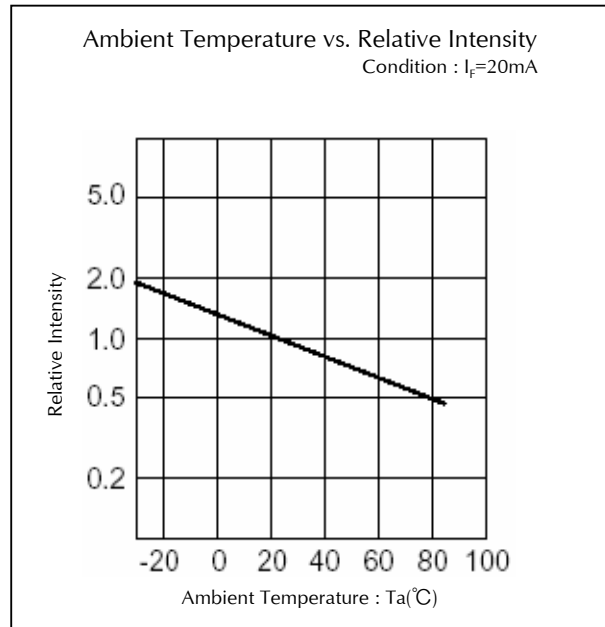
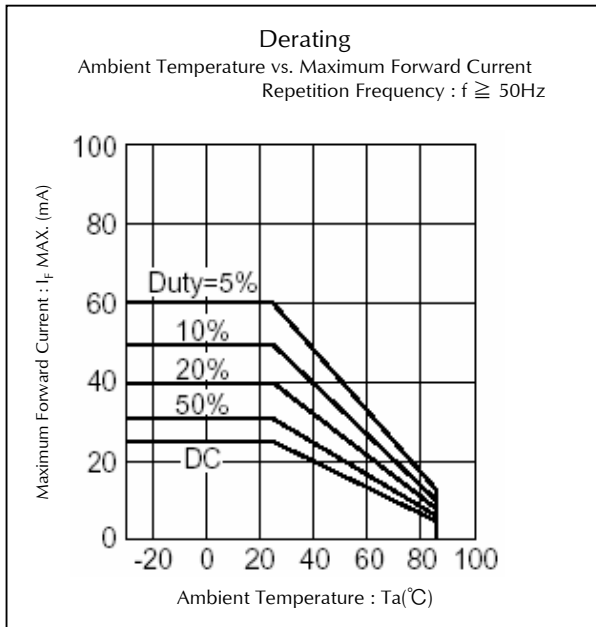
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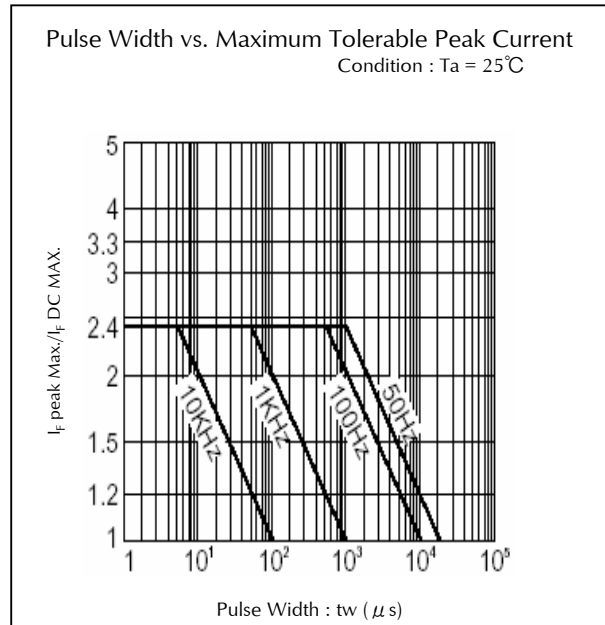
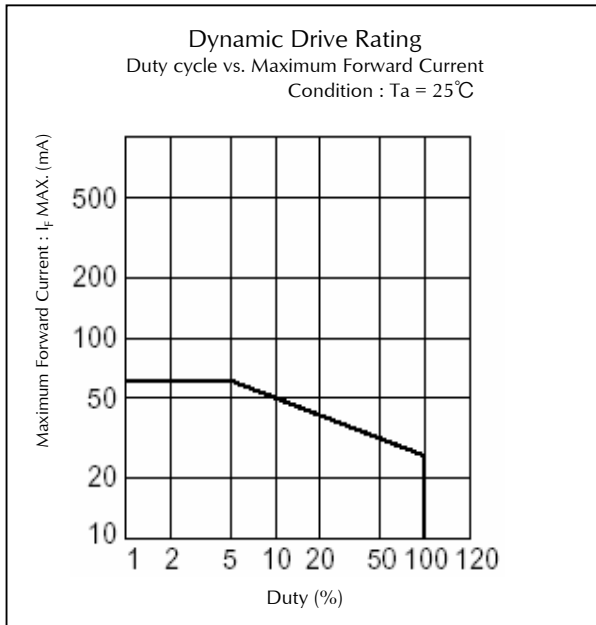
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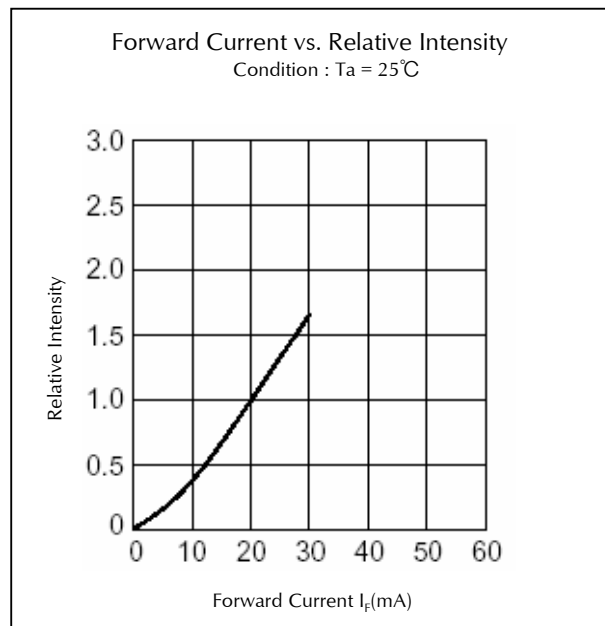
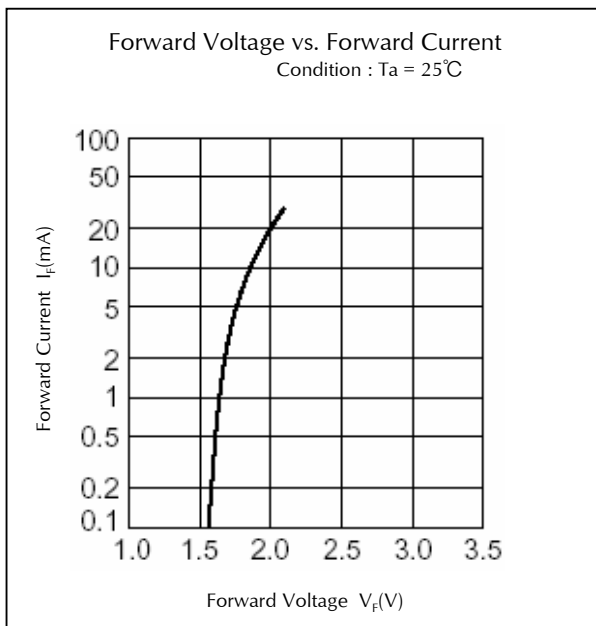
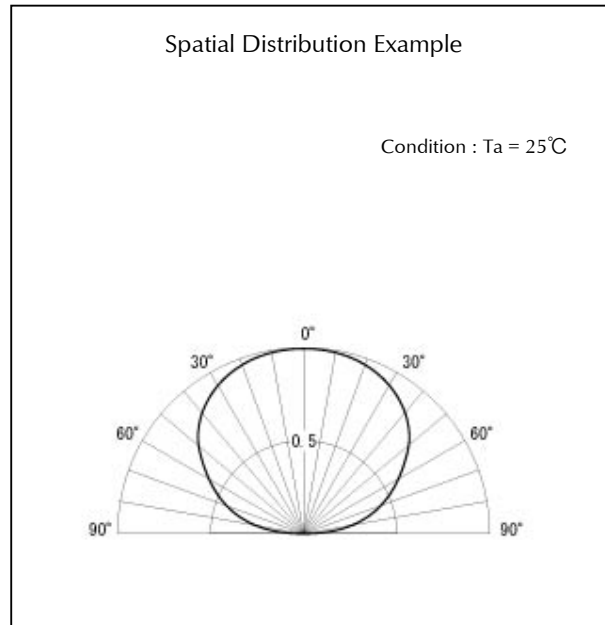
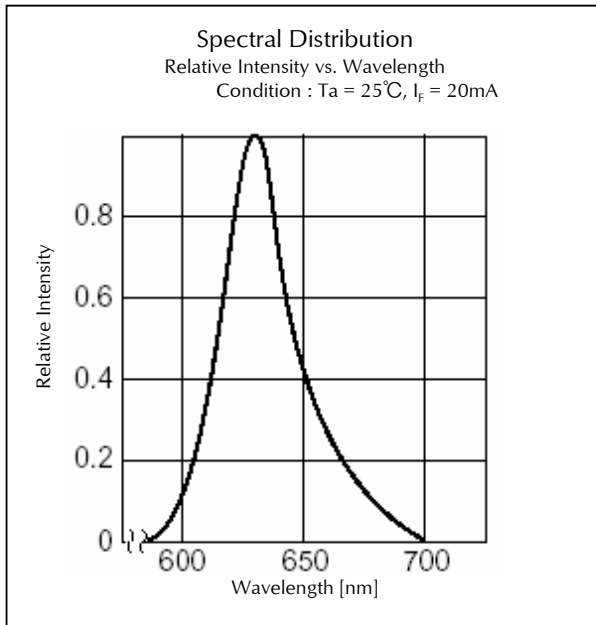
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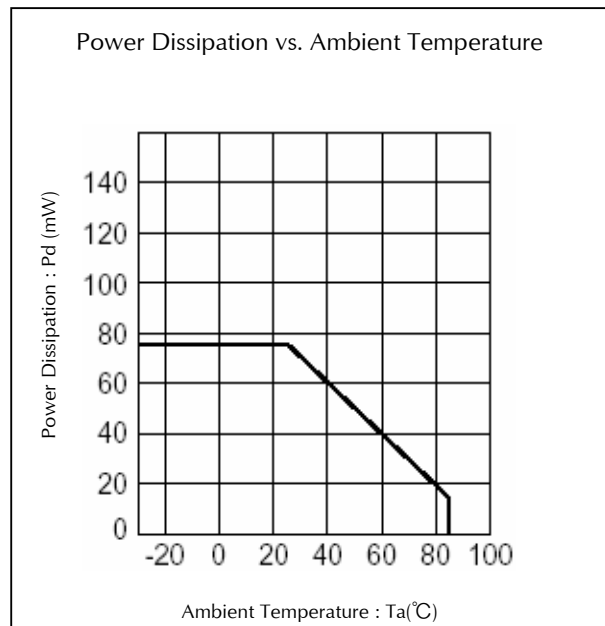
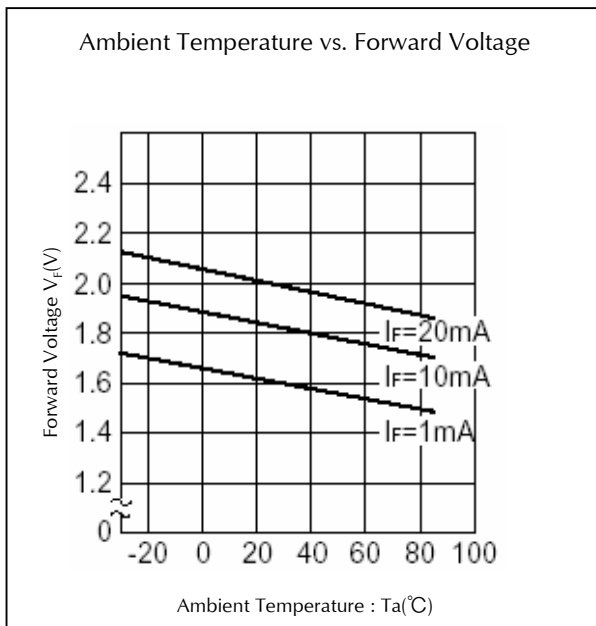
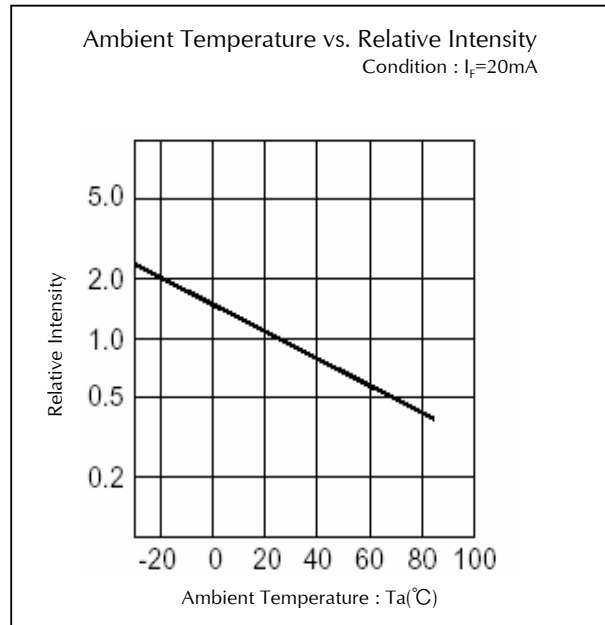
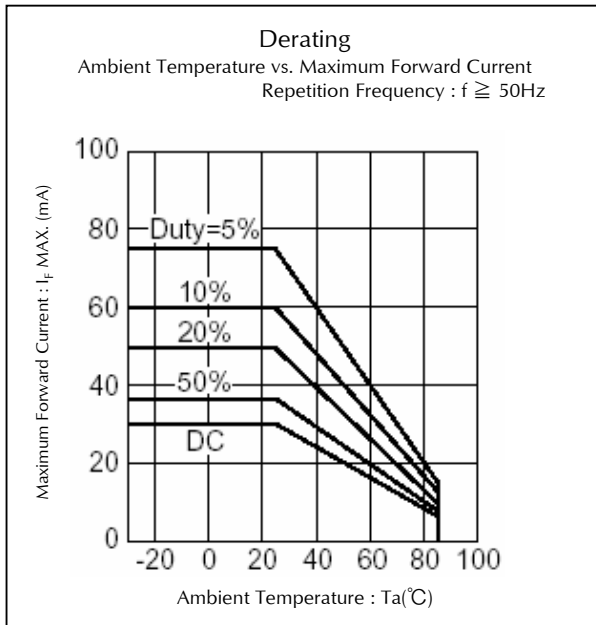
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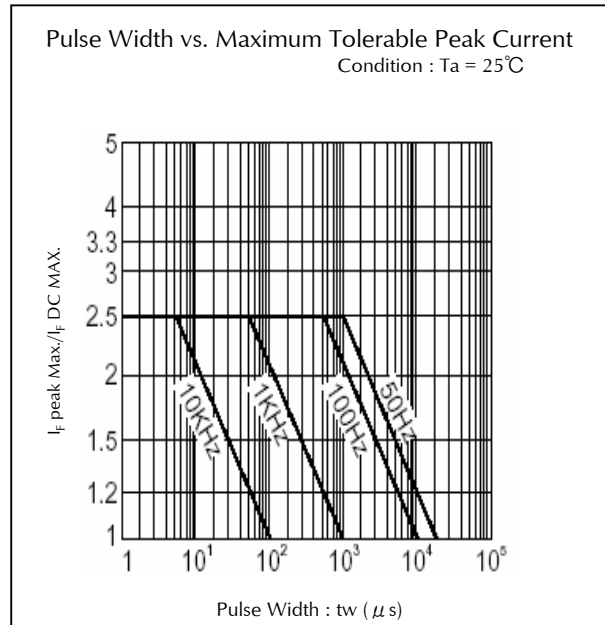
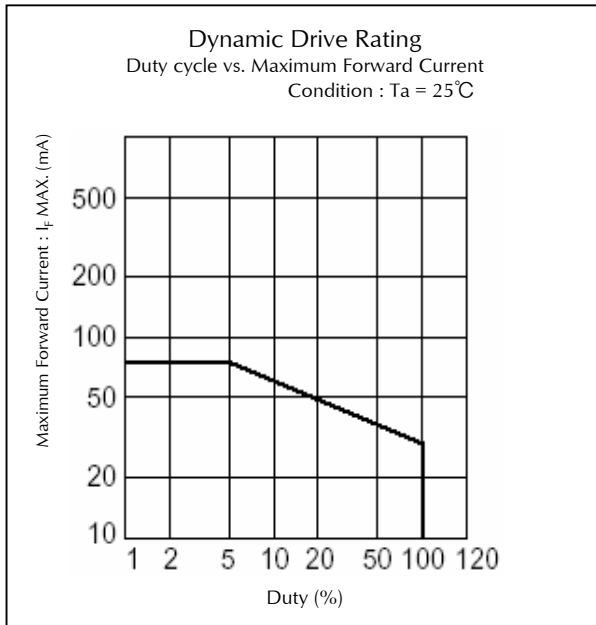
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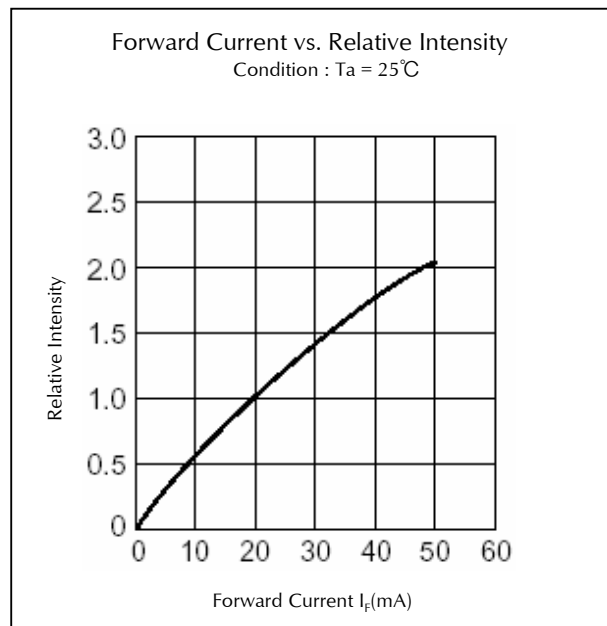
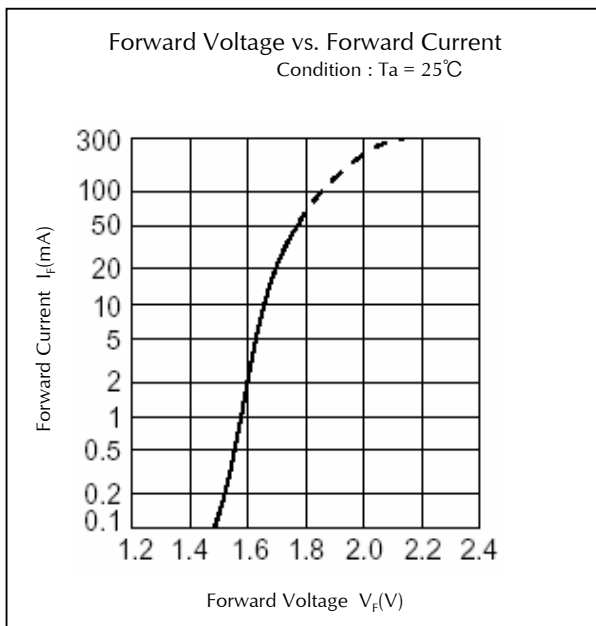
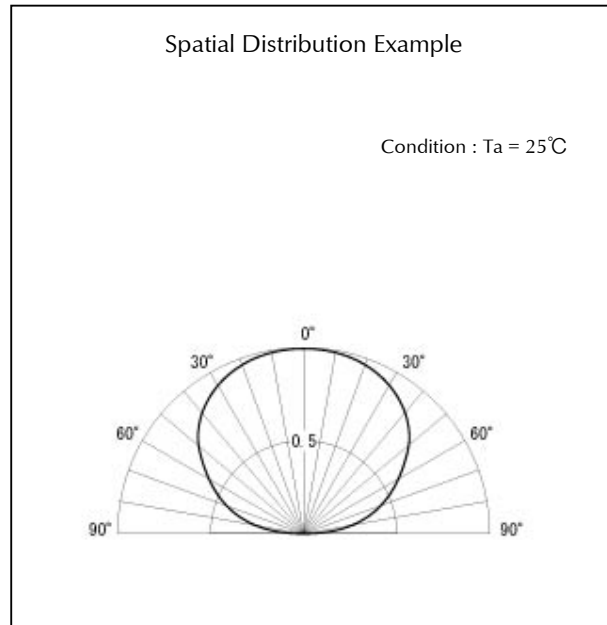
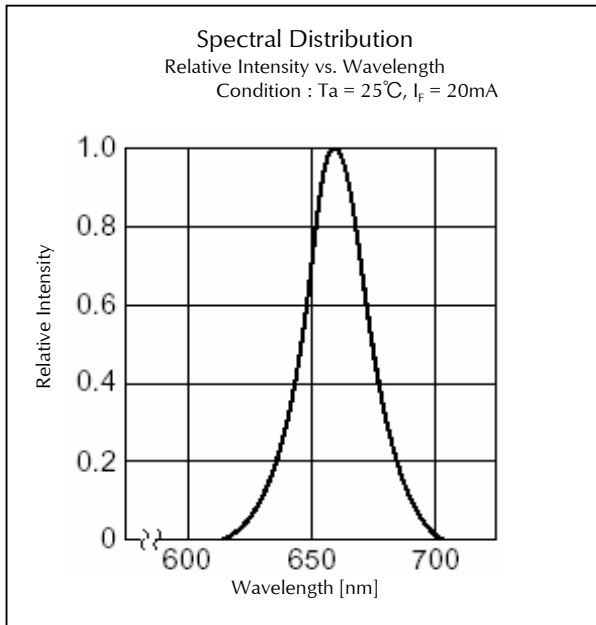
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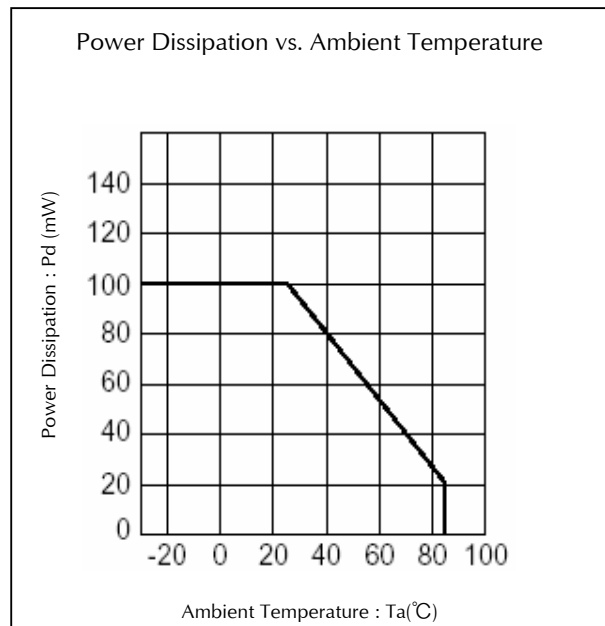
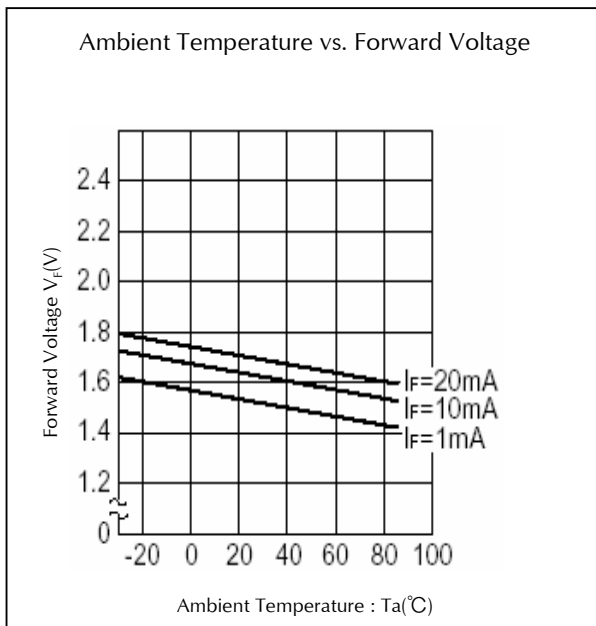
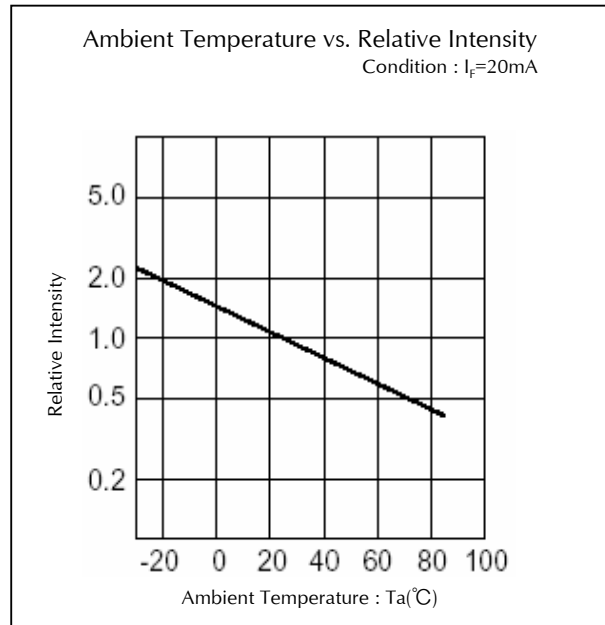
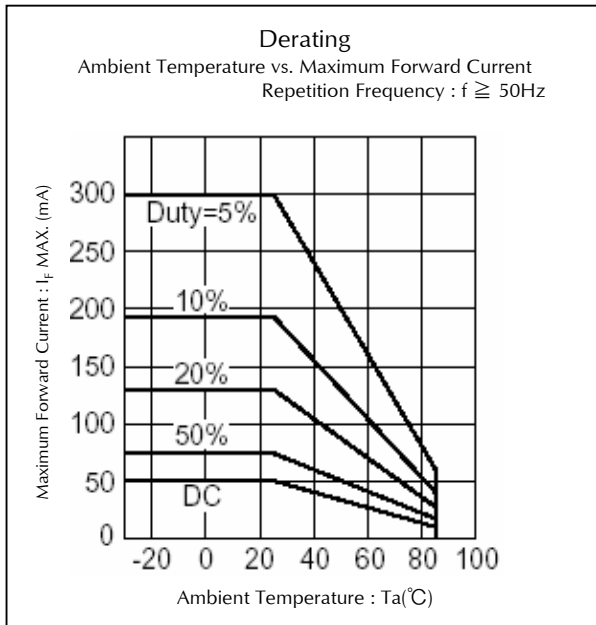
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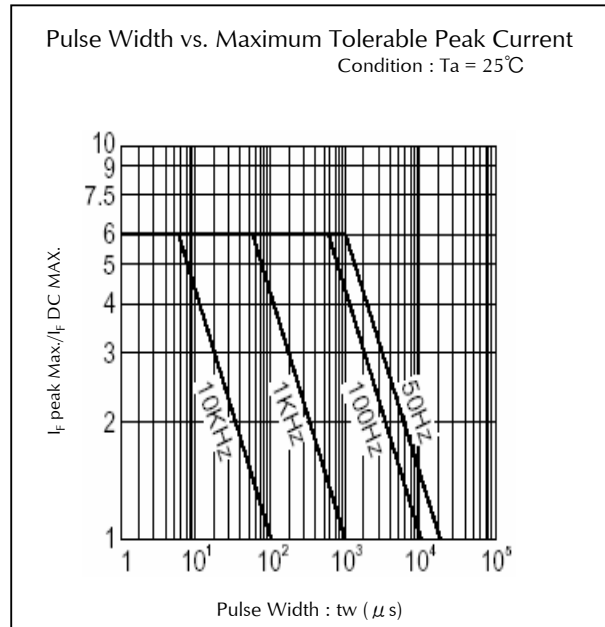
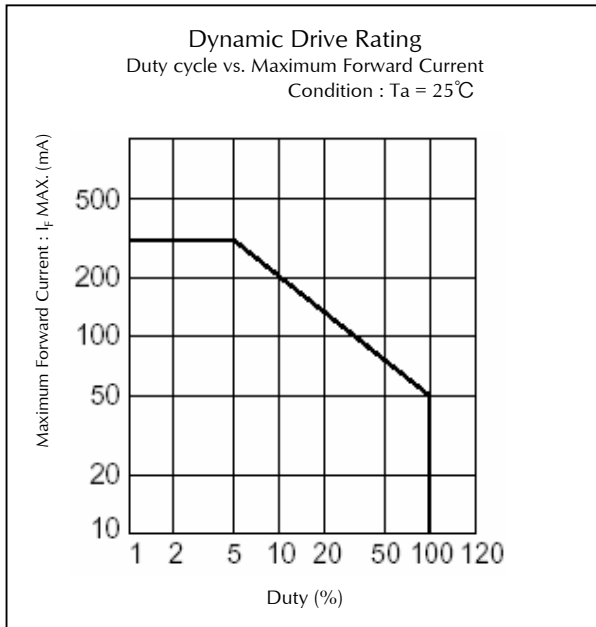
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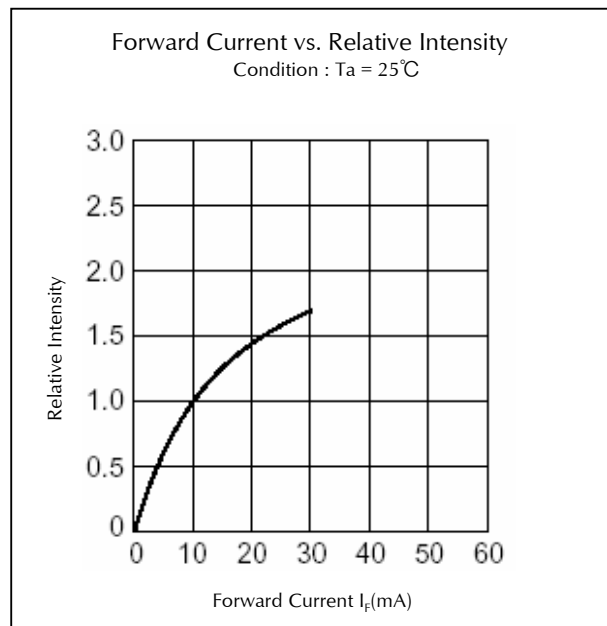
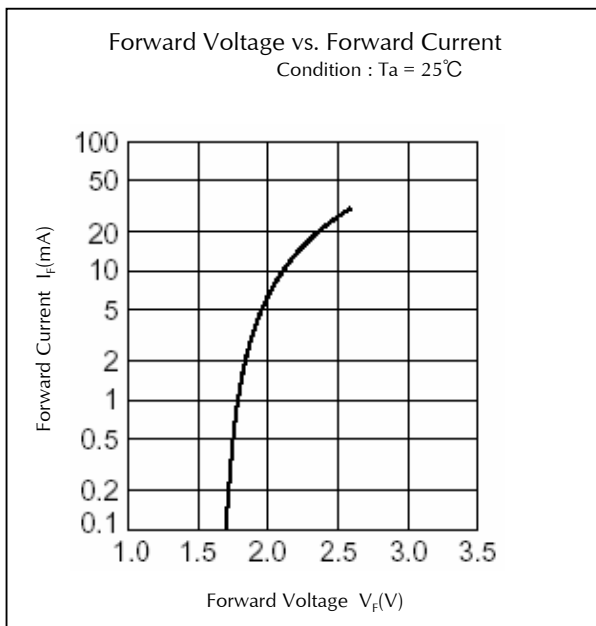
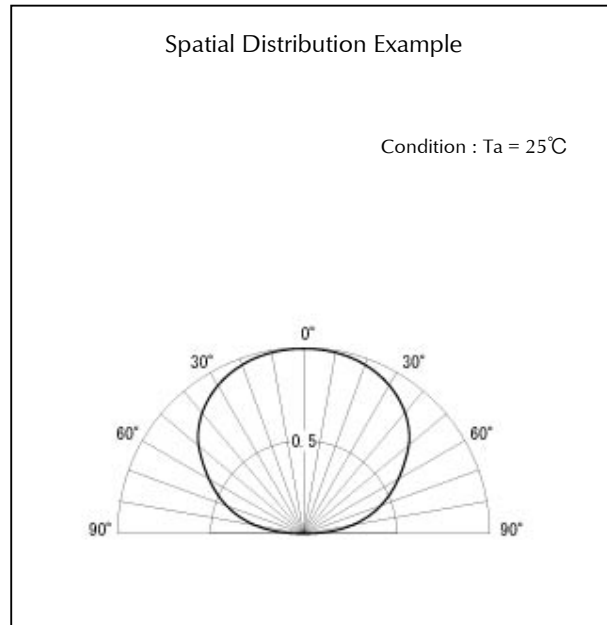
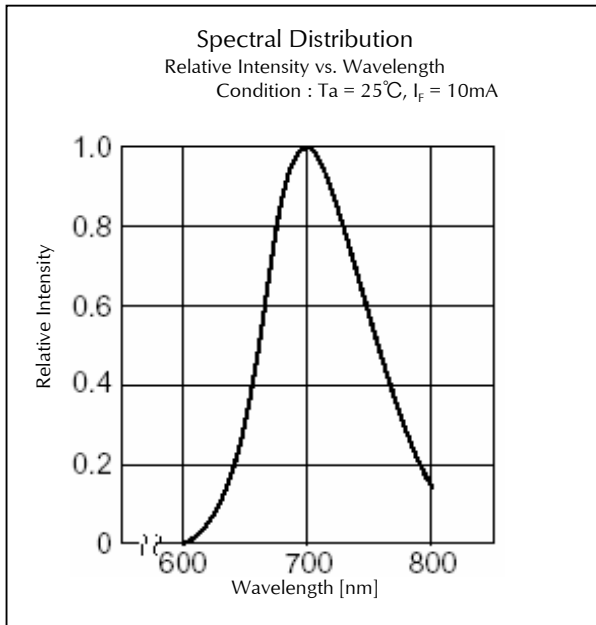
Technical Data(BR)



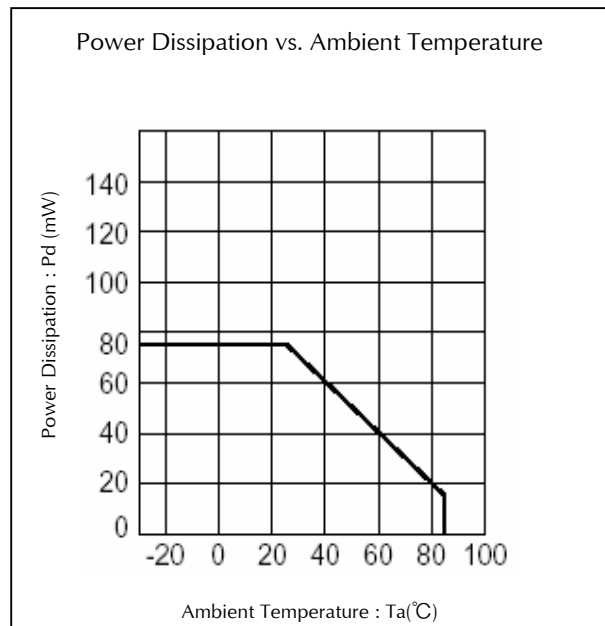
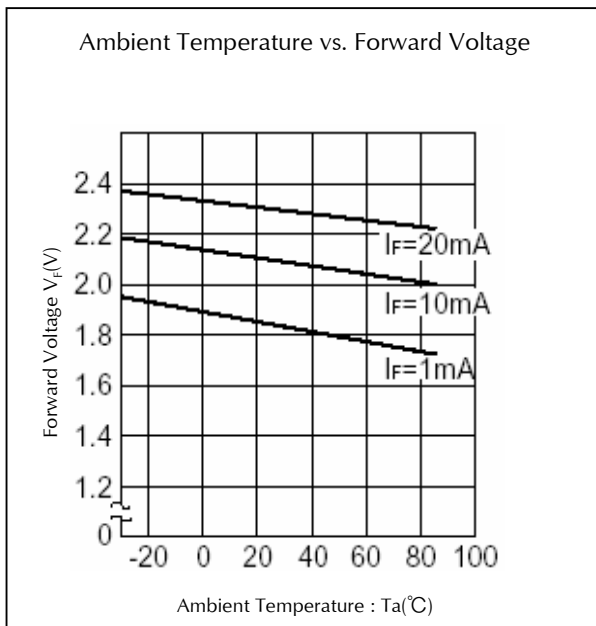
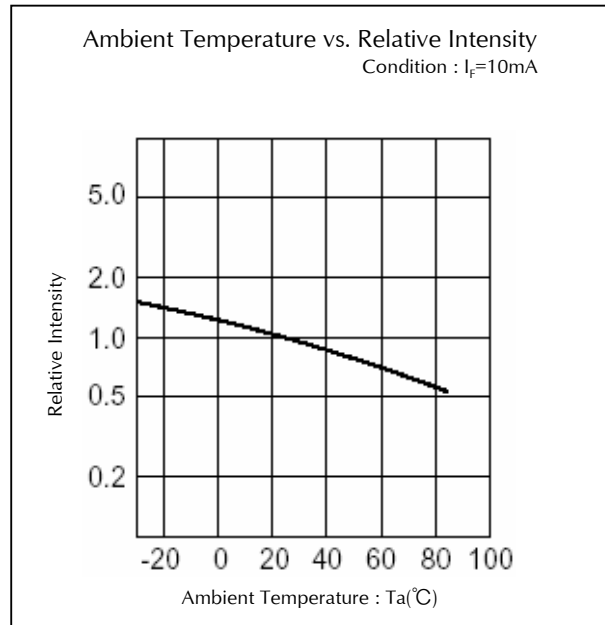
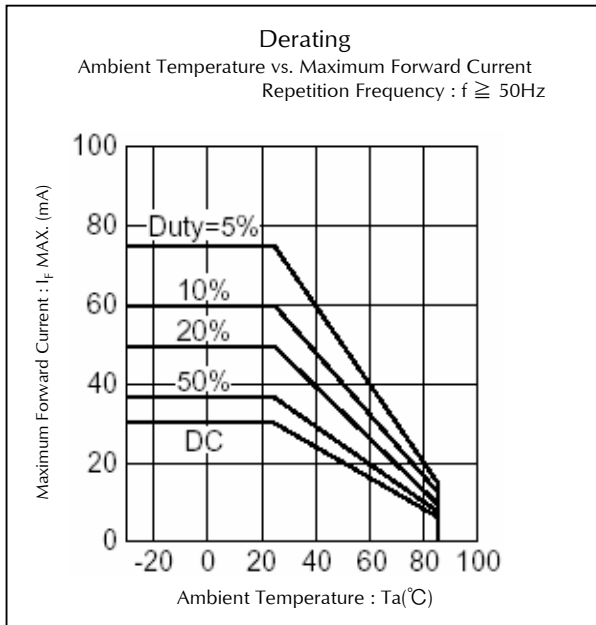
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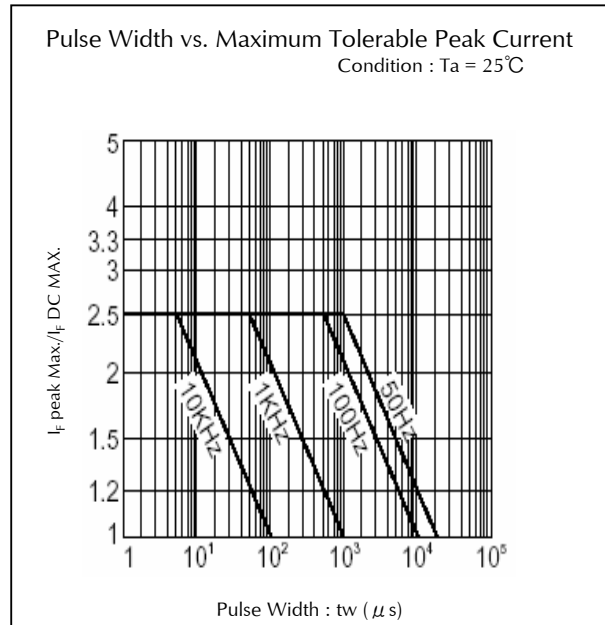
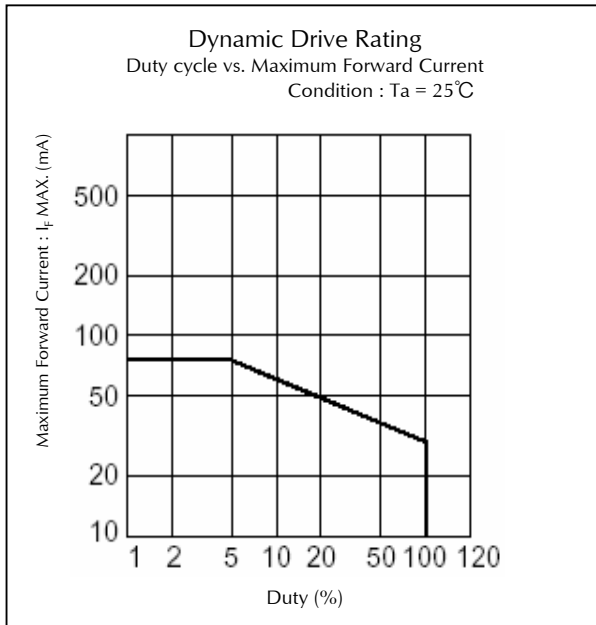
Technical Data(MPR)



Technical Data(MPR)

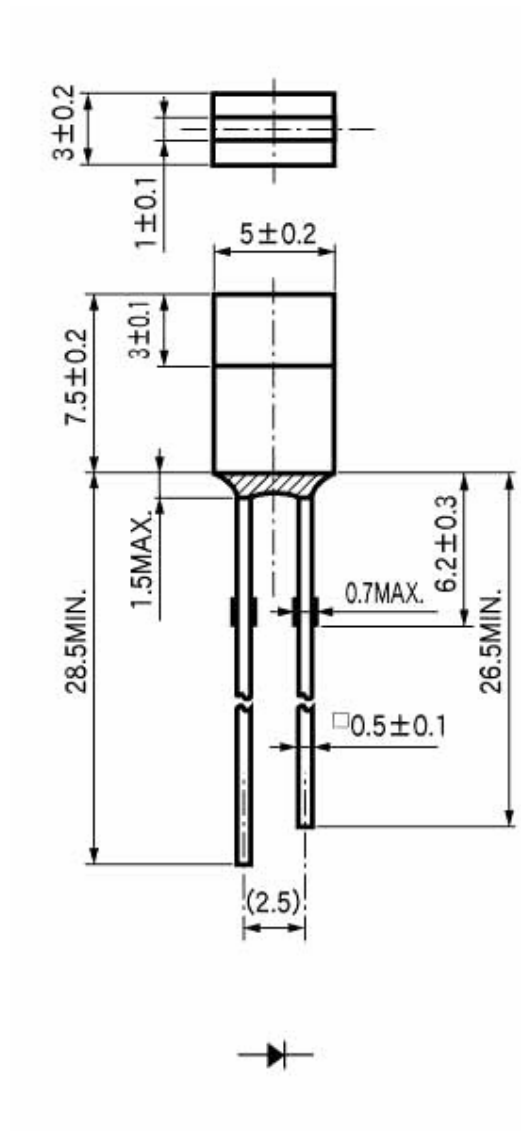


Technical Data(MPR)



Package Dimensions

(Unit: mm)



TTW (Through The Wave) soldering Conditions

Pre-heating	100 °C	(MAX.)
Solder Bath Temp.	265°C	(MAX.)
Dipping Time	5 s	(MAX.)

- 1) The dip soldering process shall be 2 times maximum.
- 2) The product shall be cooled to room temp. before the second dipping process.

※The detail is described to LED and Photodetector handling precautions of home page:
 "Mounting through-hole Type Devices" and "Soldering", and use it after the confirmation, please.

Manual Soldering Conditions

Iron tip temp.	400°C	(MAX.)
Soldering time and frequency	3 s	(MAX.)
	2 times	(MAX.)

※The detail is described to LED and Photodetector handling precautions of home page:
 "Mounting through-hole Type Devices" and "Soldering", and use it after the confirmation, please.

Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED-4701/100(101)	Ta = 25°C, If = Maximum Rated Current	1,000 h	0/25
Resistance to Soldering Heat	EIAJ ED-4701/300(302)	260±5°C, 3mm from package base	10s	0/25
Temperature Cycling	EIAJ ED-4701/100(105)	Minimum Rated Storage Temperature(30min) ~Normal Temperature(15min) ~Maximum Rated Storage Temperature(30min) ~Normal Temperature(15min)	5 cycles	0/25
Wet High Temp. Storage Life	EIAJ ED-4701/100(103)	Ta = 60±2°C, RH = 90±5%	1,000 h	0/25
High Temp. Storage Life	EIAJ ED-4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/25
Low Temp. Storage Life	EIAJ ED-4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/25
Lead Tension	EIAJ ED-4701/400(401)	10N, 1time (□0.4 and Flat Package : 5N)	10s	0/10
Vibration, Variable Frequency	EIAJ ED-4701/400(403)	98.1m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Luminous Intensity	Iv	If Value of each product Luminous Intensity	Testing Min. Value < Spec. Min. Value x 0.5
Forward Voltage	V _F	If Value of each product Forward Voltage	Testing Max. Value ≥ Spec. Max. Value x 1.2
Reverse Current	I _R	V _R = Maximum Rated Reverse Voltage V	Testing Max. Value ≥ Spec. Max. Value x 2.5
Cosmetic Appearance	-	-	Occurrence of notable decoloration, deformation and cracking

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